

## 1N60-KWQ

## 1A, 600V N-CHANNEL POWER MOSFET

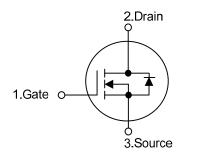
## DESCRIPTION

The UTC **1N60-KWQ** is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

### FEATURES

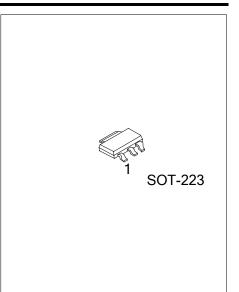
- \*  $R_{DS(ON)}$  < 23  $\Omega$  @  $V_{GS}$ =10V,  $I_D$ =0.5A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness

## SYMBOL



## ORDERING INFORMATION





## Power MOSFET

#### ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

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PARAMETER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage	V <sub>DSS</sub>	600	V	
Gate-Source Voltage	V <sub>GSS</sub>	V <sub>GSS</sub> ±30		
Continuous Drain Current	I <sub>D</sub>	1	А	
Avalanche Energy Single Pulsed (Note	2) E <sub>AS</sub>	12	mJ	
Peak Diode Recovery dv/dt (Note 3)	dv/dt	3.8	V/ns	
Power Dissipation (T <sub>A</sub> =25°C)	PD	0.8	W	
Junction Temperature	TJ	+150	°C	
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. L = 46mH,  $I_{AS}$  = 0.7A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25°C

3.  $I_{SD} \le 1.2A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

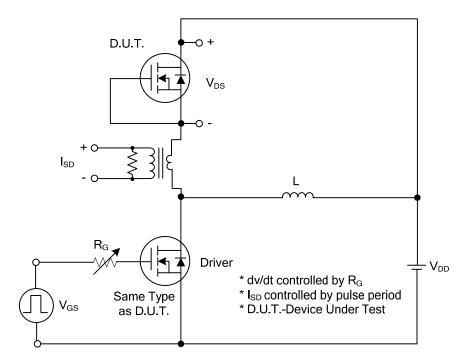
#### **THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	$\theta_{JA}$	150	°C/W
Junction to Case	θ <sub>JC</sub>	14	°C/W

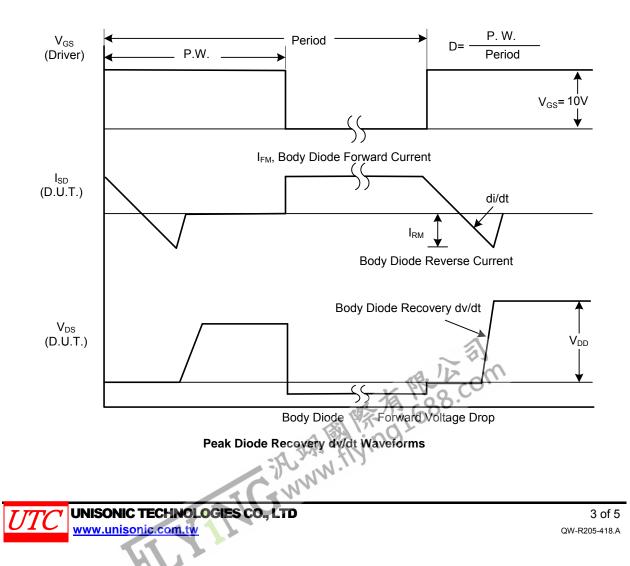
#### ELECTRICAL CHARACTERISTICS (Tc=25°C, unless otherwise specified.)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS			·						
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	600			V		
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V			10	μA		
	Forward	_	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nA		
	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		V <sub>GS(TH)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A			23	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		CISS			80		рF		
Output Capacitance		C <sub>OSS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz		14		рF		
Reverse Transfer Capacitance		C <sub>RSS</sub>			2		рF		
SWITCHING CHARACTERISTIC	S								
Total Gate Charge		Q <sub>G</sub>					nC		
Gate-Source Charge		Q <sub>GS</sub>	V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A, R <sub>G</sub> =3.3kΩ V <sub>GS</sub> =10V (Note 2,3)				nC		
Gate-Drain Charge		$Q_{GD}$	$V_{GS} = 10V$ (Note 2,3)				nC		
Turn-On Delay Time			 V <sub>DD</sub> =300V, I <sub>D</sub> =1A, R <sub>G</sub> =25Ω,		1.6		ns		
Turn-On Rise Time		t <sub>R</sub>			8.5		ns		
Turn-Off Delay Time		t <sub>D(OFF)</sub>	V <sub>GS</sub> =10V (Note 2,3)		1.6		ns		
Turn-Off Fall Time		t <sub>F</sub>			32.2		ns		
SOURCE-DRAIN DIODE RATIN	GS AND CH	IARACTERIS	STICS						
Maximum Continuous Drain-Sour	ce Diode					1.0	_		
Forward Current		I <sub>S</sub>	~ 12			1.0	A		
Drain-Source Diode Forward Volt	age	V <sub>SD</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V	2		1.4	V		
Reverse Recovery Time		t <sub>rr</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V	*	300		μs		
Reverse Recovery Charge		Qrr	dl <sub>F</sub> /dt=100A/µs (Note 1)		0.44		μC		
Notes: 1. Pulse Test: Pulse width	≤ 300µs, D	uty cycle ≤ 2%	%. S. M. J.						
<ol><li>Essentially independent of operating temperature.</li></ol>									
<ul> <li>Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.</li> <li>2. Essentially independent of operating temperature.</li> </ul>									
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## TEST CIRCUITS AND WAVEFORMS

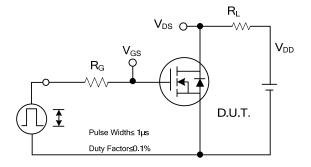


Peak Diode Recovery dv/dt Test Circuit

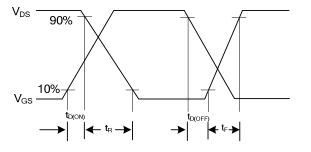


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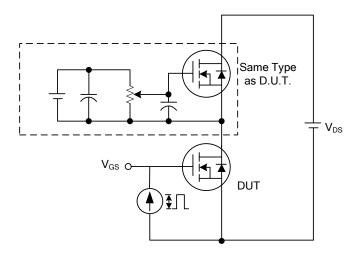
## **TEST CIRCUITS AND WAVEFORMS**



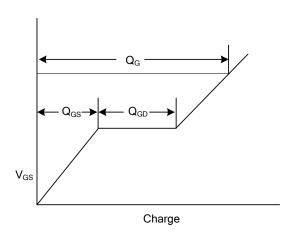
**Switching Test Circuit** 



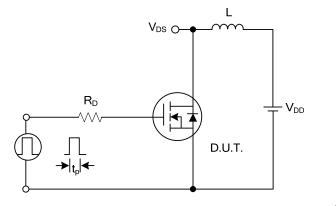
**Switching Waveforms** 

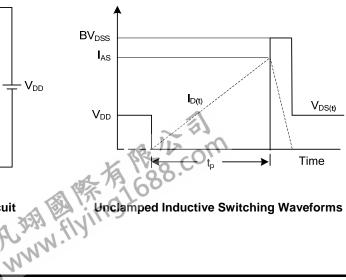






**Gate Charge Waveform** 





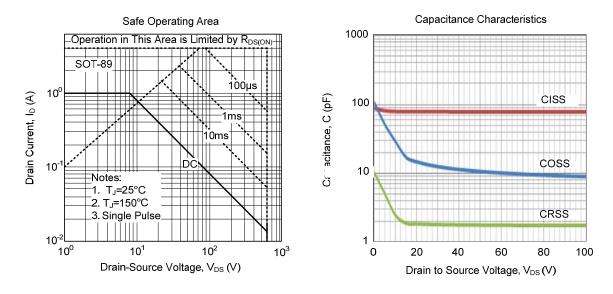
**Unclamped Inductive Switching Test Circuit** 



# 1N60-KWQ

## Power MOSFET

## TYPICAL CHARACTERISTICS



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